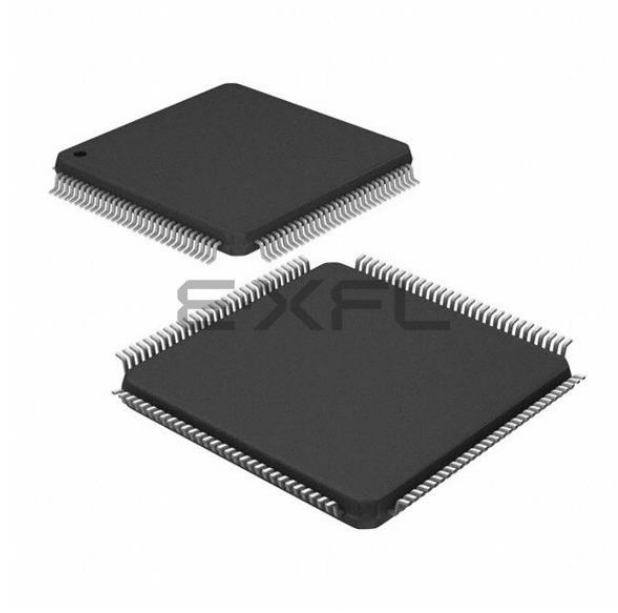
Infineon Technologies - MB96F6A6RBPMC-GSE1 Datasheet



Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-16FX
Core Size	16-Bit
Speed	32MHz
Connectivity	CANbus, I²C, LINbus, SCI, UART/USART
Peripherals	DMA, LCD, LVD, POR, PWM, WDT
Number of I/O	97
Program Memory Size	288KB (288K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 32x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	120-LQFP
Supplier Device Package	120-LQFP (16x16)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb96f6a6rbpmc-gse1

- All SEG, COM and V pins can be switched between general and specialized purposes

Sound Generator

- 8-bit PWM signal is mixed with tone frequency from 16-bit reload counter
- PWM clock by internal prescaler: 1, 1/2, 1/4, 1/8 of peripheral clock

Real Time Clock

- Operational on main oscillation (4MHz), sub oscillation (32kHz) or RC oscillation (100kHz/2MHz)
- Capable to correct oscillation deviation of Sub clock or RC oscillator clock (clock calibration)
- Read/write accessible second/minute/hour registers
- Can signal interrupts every half second/second/minute/hour/day
- Internal clock divider and prescaler provide exact 1s clock

External Interrupts

- Edge or Level sensitive
- Interrupt mask bit per channel
- Each available CAN channel RX has an external interrupt for wake-up
- Selected USART channels SIN have an external interrupt for wake-up

Non Maskable Interrupt

- Disabled after reset, can be enabled by Boot-ROM depending on ROM configuration block
- Once enabled, cannot be disabled other than by reset
- High or Low level sensitive
- Pin shared with external interrupt 0

I/O Ports

- Most of the external pins can be used as general purpose I/O
- All push-pull outputs (except when used as I^2C SDA/SCL line)
- Bit-wise programmable as input/output or peripheral signal
- Bit-wise programmable input enable
- One input level per GPIO-pin (either Automotive or CMOS hysteresis)
- Bit-wise programmable pull-up resistor

Built-in On Chip Debugger (OCD)

- One-wire debug tool interface
- Break function
  - Hardware break: 6 points (shared with code event)
  - Software break: 4096 points
- Event function
  - Code event: 6 points (shared with hardware break)
  - Data event: 6 points
  - Event sequencer: 2 levels + reset
- Execution time measurement function
- Trace function: 42 branches
- Security function

Flash Memory

- Dual operation flash allowing reading of one Flash bank while programming or erasing the other bank
- Command sequencer for automatic execution of programming algorithm and for supporting DMA for programming of the Flash Memory
- Supports automatic programming, Embedded Algorithm
- Write/Erase/Erase-Suspend/Resume commands
- A flag indicating completion of the automatic algorithm
- Erase can be performed on each sector individually
- Sector protection
- Flash Security feature to protect the content of the Flash
- Low voltage detection during Flash erase or write

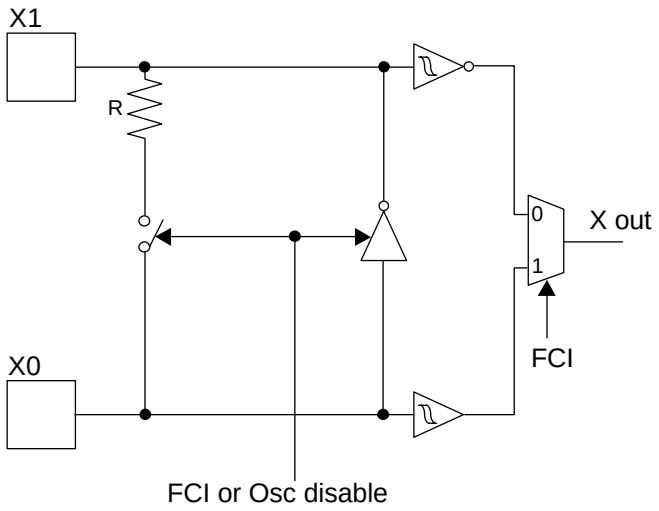
1. Product Lineup

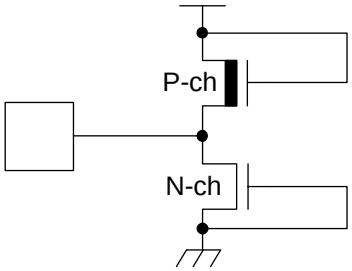
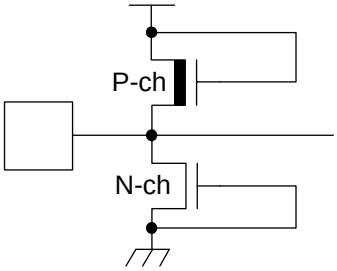
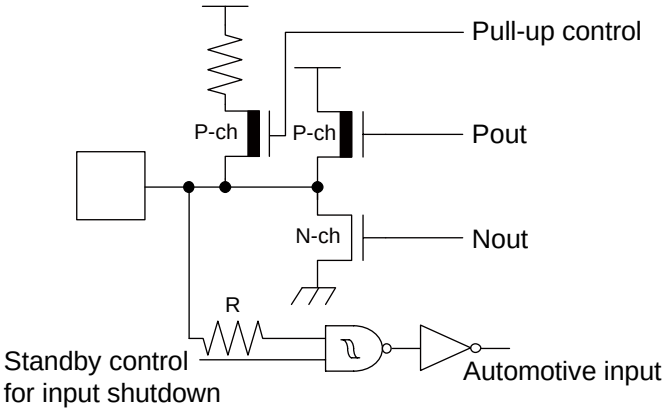
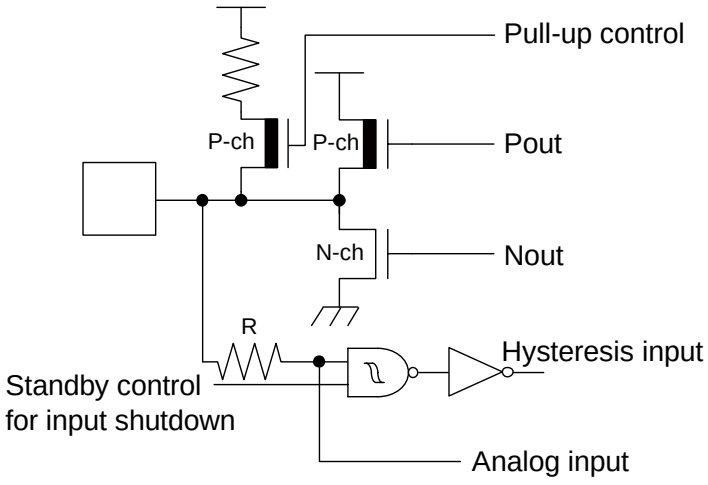
Features			CY966A0	Remark
Product Type			Flash Memory Product	
Subclock			Subclock can be set by software	
Dual Operation Flash Memory		RAM	-	
128.5KB + 32KB		8KB	CY96F6A5R, CY96F6A5A	Product Options R: MCU with CAN A: MCU without CAN
256.5KB + 32KB		16KB	CY96F6A6R	
Package			LQFP-120 LQM120	
DMA			4ch	
USART			5ch	LIN-USART 0 to 2/4/5
	with automatic LIN-Header transmission/reception		2ch	LIN-USART 0/1
	with 16 byte RX- and TX-FIFO			
I^2C			1ch	I^2C 0
8/10-bit A/D Converter			32ch	AN 0 to 31
	with Data Buffer		No	
	with Range Comparator		Yes	
	with Scan Disable		Yes	
	with ADC Pulse Detection		Yes	
16-bit Reload Timer (RLT)			5ch	RLT 0 to 3/6
16-bit Free-Running Timer (FRT)			2ch	FRT 0/1
16-bit Input Capture Unit (ICU)			8ch (5 channels for LIN-USART)	ICU 0 to 7 (ICU 0/1/4 to 6 for LIN-USART)
16-bit Output Compare Unit (OCU)			4ch	OCU 0 to 3
8/16-bit Programmable Pulse Generator (PPG)			12ch (16-bit) / 24ch (8-bit)	PPG 0 to 7/12 to 15
	with Timing point capture		Yes	
	with Start delay		Yes	
	with Ramp		No	
CAN Interface			1ch	CAN 0 32 Message Buffers
Stepping Motor Controller (SMC)			5ch	SMC 0 to 4
External Interrupts (INT)			16ch	INT 0 to 15
Non-Maskable Interrupt (NMI)			1ch	
Sound Generator (SG)			2ch	SG 0/1
LCD Controller			4COM × 44SEG	COM 0 to 3 SEG 0 to 4/7 to 45
Real Time Clock (RTC)			1ch	
I/O Ports			95 (Dual clock mode) 97 (Single clock mode)	
Clock Calibration Unit (CAL)			1ch	
Clock Output Function			2ch	
Low Voltage Detection Function			Yes	Low voltage detection function can be disabled by software
Hardware Watchdog Timer			Yes	
On-chip RC-oscillator			Yes	
On-chip Debugger			Yes	

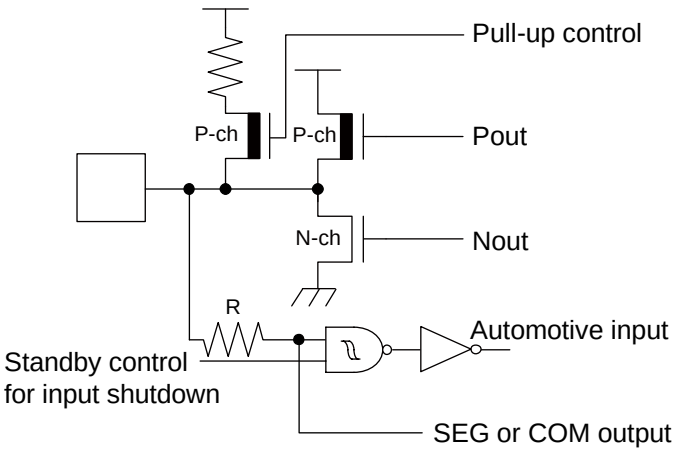
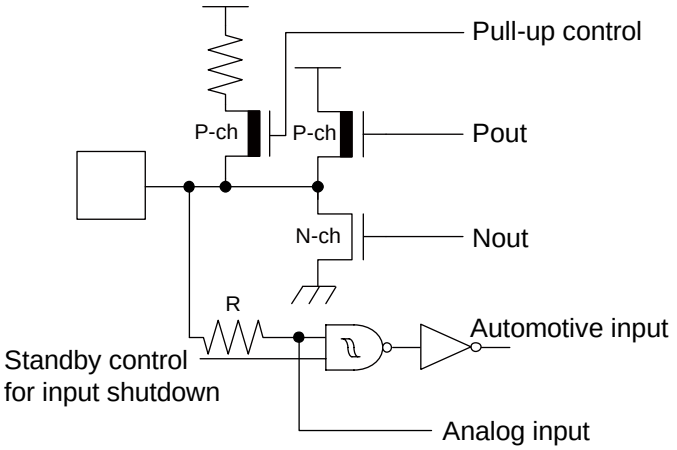
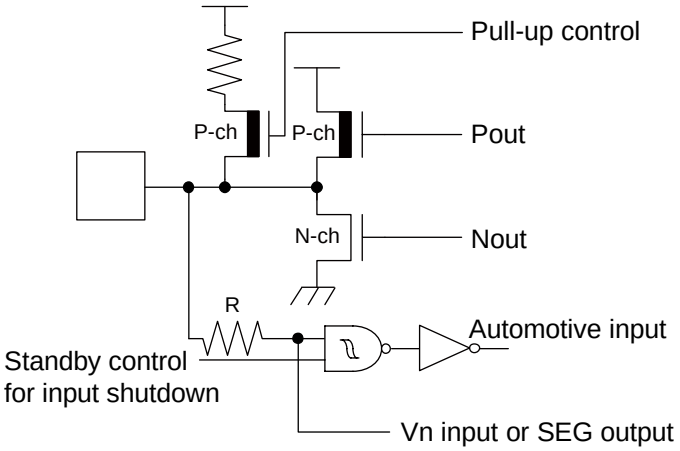
Note: All signals of the peripheral function in each product cannot be allocated by limiting the pins of package.
It is necessary to use the port relocate function of the general I/O port according to your function use.

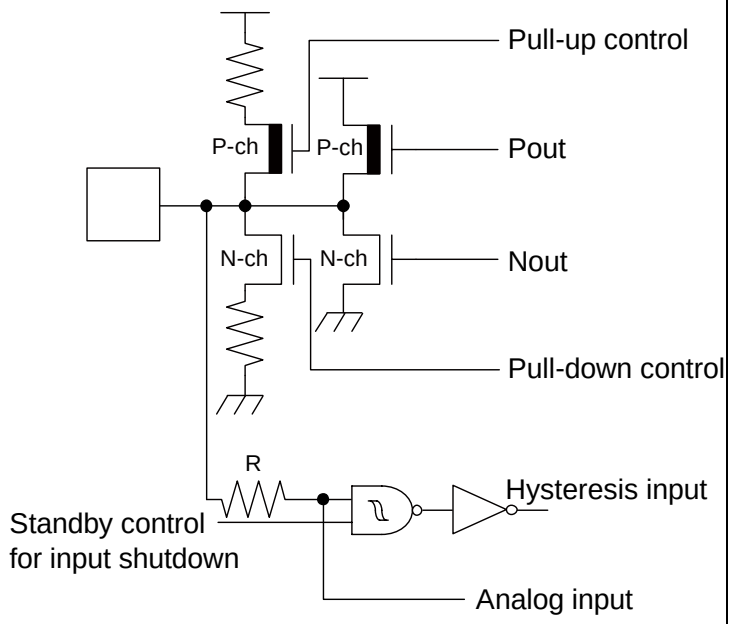
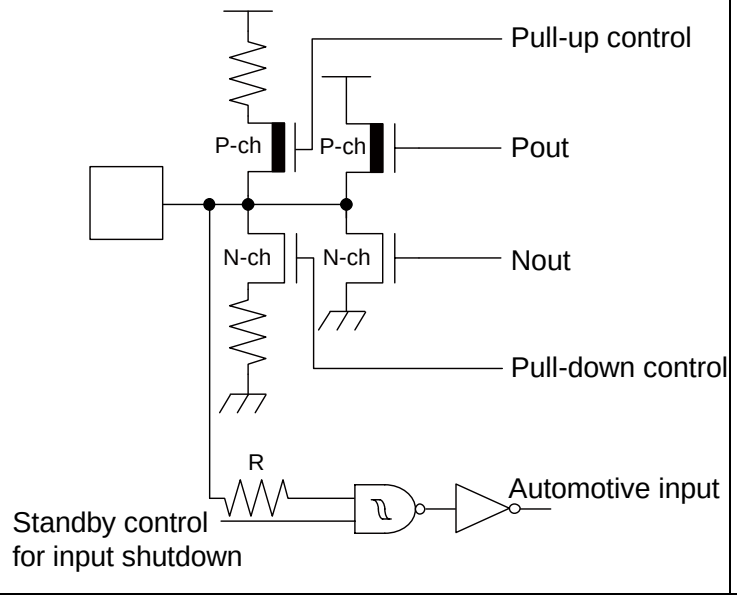
Pin Name	Feature	Description
SGOn_R	Sound Generator	Relocated Sound Generator sound/tone output pin
SINn	USART	USART n serial data input pin
SINn_R	USART	Relocated USART n serial data input pin
SOTn	USART	USART n serial data output pin
SOTn_R	USART	Relocated USART n serial data output pin
TINn	Reload Timer	Reload Timer n event input pin
TINn_R	Reload Timer	Relocated Reload Timer n event input pin
TOTn	Reload Timer	Reload Timer n output pin
TOTn_R	Reload Timer	Relocated Reload Timer n output pin
TTGn	PPG	Programmable Pulse Generator n trigger input pin
TXn	CAN	CAN interface n TX output pin
Vn	LCD	LCD voltage reference pin
Vcc	Supply	Power supply pin
Vss	Supply	Power supply pin
WOT	RTC	Real Time clock output pin
WOT_R	RTC	Relocated Real Time clock output pin
X0	Clock	Oscillator input pin
X0A	Clock	Subclock Oscillator input pin
X1	Clock	Oscillator output pin
X1A	Clock	Subclock Oscillator output pin

6. I/O Circuit Type

Type	Circuit	Remarks
A		High-speed oscillation circuit: ■ Programmable between oscillation mode (external crystal or resonator connected to X0/X1 pins) and Fast external Clock Input (FCI) mode (external clock connected to X0 pin) ■ Feedback resistor = approx. 1.0MΩ ■ The amplitude: 1.8V±0.15V to operate by the internal supply voltage

Type	Circuit	Remarks
F		Power supply input protection circuit
G		■A/D converter ref+ (AVRH)/ ref- (AVRL) power supply input pin with protection circuit ■Without protection circuit against V_{CC} for pins AVRH/AVRL
H		■CMOS level output (I_{OL} = 4mA, I_{OH} = -4mA) ■Automotive input with input shutdown function ■Programmable pull-up resistor
I		■CMOS level output (I_{OL} = 4mA, I_{OH} = -4mA) ■CMOS hysteresis input with input shutdown function ■Programmable pull-up resistor ■Analog input

Type	Circuit	Remarks
J		■CMOS level output (I_{OL} = 4mA, I_{OH} = -4mA) ■Automotive input with input shutdown function ■Programmable pull-up resistor ■SEG or COM output
K		■CMOS level output (I_{OL} = 4mA, I_{OH} = -4mA) ■Automotive input with input shutdown function ■Programmable pull-up resistor ■Analog input
L		■CMOS level output (I_{OL} = 4mA, I_{OH} = -4mA) ■Automotive input with input shutdown function ■Programmable pull-up resistor ■Vn input or SEG output

Type	Circuit	Remarks
S		■CMOS level output (programmable I_{OL} = 4mA, I_{OH} = -4mA and I_{OL} = 30mA, I_{OH} = -30mA) ■CMOS hysteresis input with input shutdown function ■Programmable pull-up / pull-down resistor ■Analog input
T		■CMOS level output (programmable I_{OL} = 4mA, I_{OH} = -4mA and I_{OL} = 30mA, I_{OH} = -30mA) ■Automotive input with input shutdown function ■Programmable pull-up / pull-down resistor

Vector Number	Offset in Vector Table	Vector Name	Cleared by DMA	Index in ICR to Program	Description
116	$22C_H$	-	-	116	Reserved
117	228_H	-	-	117	Reserved
118	224_H	-	-	118	Reserved
119	220_H	-	-	119	Reserved
120	$21C_H$	-	-	120	Reserved
121	218_H	SG1	No	121	Sound Generator 1
122	214_H	-	-	122	Reserved
123	210_H	-	-	123	Reserved
124	$20C_H$	-	-	124	Reserved
125	208_H	-	-	125	Reserved
126	204_H	-	-	126	Reserved
127	200_H	-	-	127	Reserved
128	$1FC_H$	-	-	128	Reserved
129	$1F8_H$	-	-	129	Reserved
130	$1F4_H$	-	-	130	Reserved
131	$1F0_H$	-	-	131	Reserved
132	$1EC_H$	-	-	132	Reserved
133	$1E8_H$	FLASHA	Yes	133	Flash memory A interrupt
134	$1E4_H$	-	-	134	Reserved
135	$1E0_H$	-	-	135	Reserved
136	$1DC_H$	-	-	136	Reserved
137	$1D8_H$	-	-	137	Reserved
138	$1D4_H$	-	-	138	Reserved
139	$1D0_H$	ADCRC0	No	139	A/D Converter 0 - Range Comparator
140	$1CC_H$	ADCPD0	No	140	A/D Converter 0 - Pulse detection
141	$1C8_H$	-	-	141	Reserved
142	$1C4_H$	-	-	142	Reserved
143	$1C0_H$	-	-	143	Reserved

13. HANDLING DEVICES

Special Care is Required for the following when Handling the Device:

- Latch-up prevention
- Unused pins handling
- External clock usage
- Notes on PLL clock mode operation
- Power supply pins (Vcc/Vss)
- Crystal oscillator and ceramic resonator circuit
- Turn on sequence of power supply to A/D converter and analog inputs
- Pin handling when not using the A/D converter
- Notes on Power-on
- Stabilization of power supply voltage
- SMC power supply pins
- Serial communication
- Mode Pin (MD)

1. Latch-Up Prevention

CMOS IC chips may suffer latch-up under the following conditions:

- A voltage higher than V_{CC} or lower than V_{SS} is applied to an input or output pin.
- A voltage higher than the rated voltage is applied between Vcc pins and Vss pins.
- The AV_{CC} power supply is applied before the V_{CC} voltage.

Latch-up may increase the power supply current dramatically, causing thermal damages to the device.
For the same reason, extra care is required to not let the analog power-supply voltage (AV_{CC}, AVRH) exceed the digital power-supply voltage.

2. Unused Pins Handling

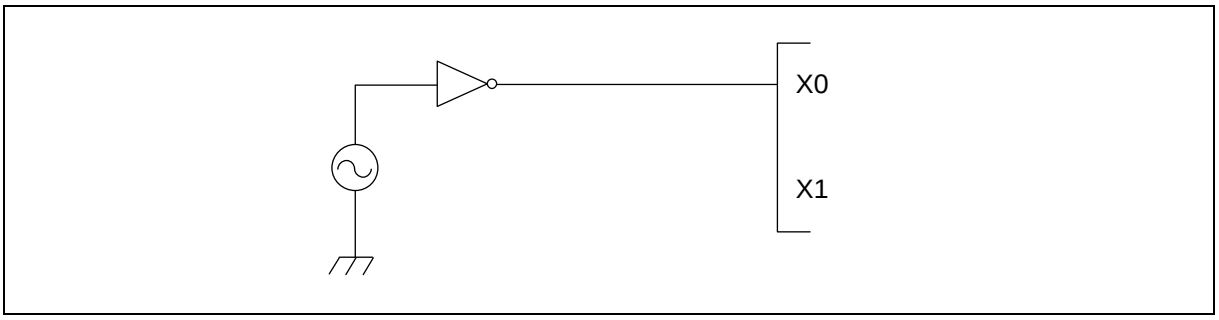
Unused input pins can be left open when the input is disabled (corresponding bit of Port Input Enable register PIER = 0).
Leaving unused input pins open when the input is enabled may result in misbehavior and possible permanent damage of the device. To prevent latch-up, they must therefore be pulled up or pulled down through resistors which should be more than 2kΩ..
Unused bidirectional pins can be set either to the output state and be then left open, or to the input state with either input disabled or external pull-up/pull-down resistor as described above.

3. External Clock Usage

The permitted frequency range of an external clock depends on the oscillator type and configuration.
See AC Characteristics for detailed modes and frequency limits. Single and opposite phase external clocks must be connected as follows:

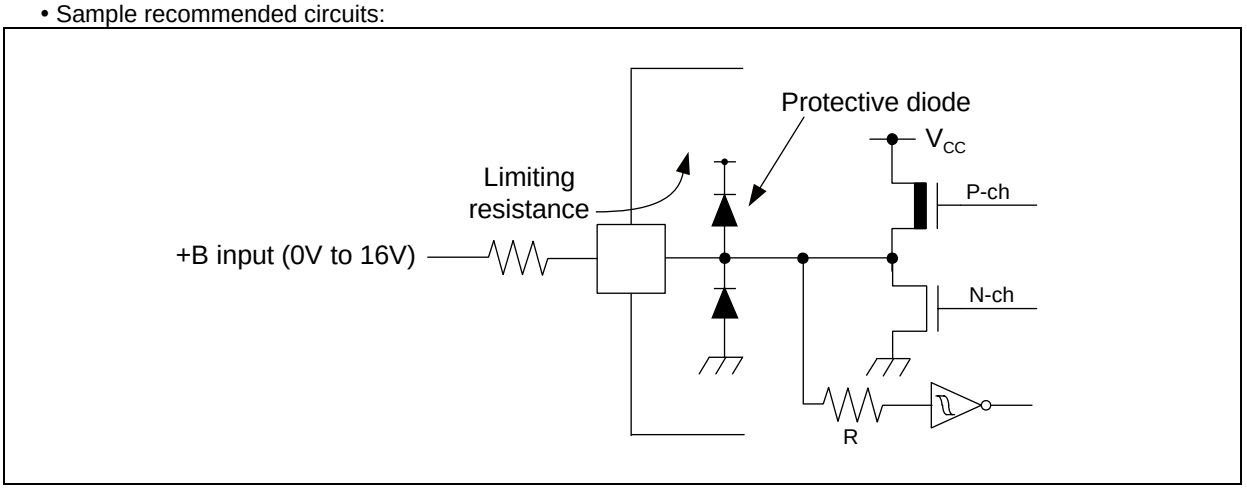
(1) Single Phase External Clock for Main Oscillator

When using a single phase external clock for the Main oscillator, X0 pin must be driven and X1 pin left open.
And supply 1.8V power to the external clock.


X0
X1

- Use at DC voltage (current).
- The +B signal should always be applied a limiting resistance placed between the +B signal and the microcontroller.
- The value of the limiting resistance should be set so that when the +B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.
- Note that if a +B signal is input when the microcontroller power supply is off (not fixed at 0V), the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the Power reset.
- The DEBUG I/F pin has only a protective diode against V_{SS}. Hence it is only permitted to input a negative clamping current (4mA). For protection against positive input voltages, use an external clamping diode which limits the input voltage to maximum 6.0V.

• Sample recommended circuits:



*5: The maximum permitted power dissipation depends on the ambient temperature, the air flow velocity and the thermal conductance of the package on the PCB.
The actual power dissipation depends on the customer application and can be calculated as follows:
$P_D = P_{IO} + P_{INT}$
$P_{IO} = \Sigma (V_{OL} \times I_{OL} + V_{OH} \times I_{OH})$ (I/O load power dissipation, sum is performed on all I/O ports)
$P_{INT} = V_{CC} \times (I_{CC} + I_A)$ (internal power dissipation)
I_{CC} is the total core current consumption into V_{CC} as described in the “DC characteristics” and depends on the selected operation mode and clock frequency and the usage of functions like Flash programming.
I_A is the analog current consumption into AV_{CC}.

*6: Worst case value for a package mounted on single layer PCB at specified T_A without air flow.

WARNING

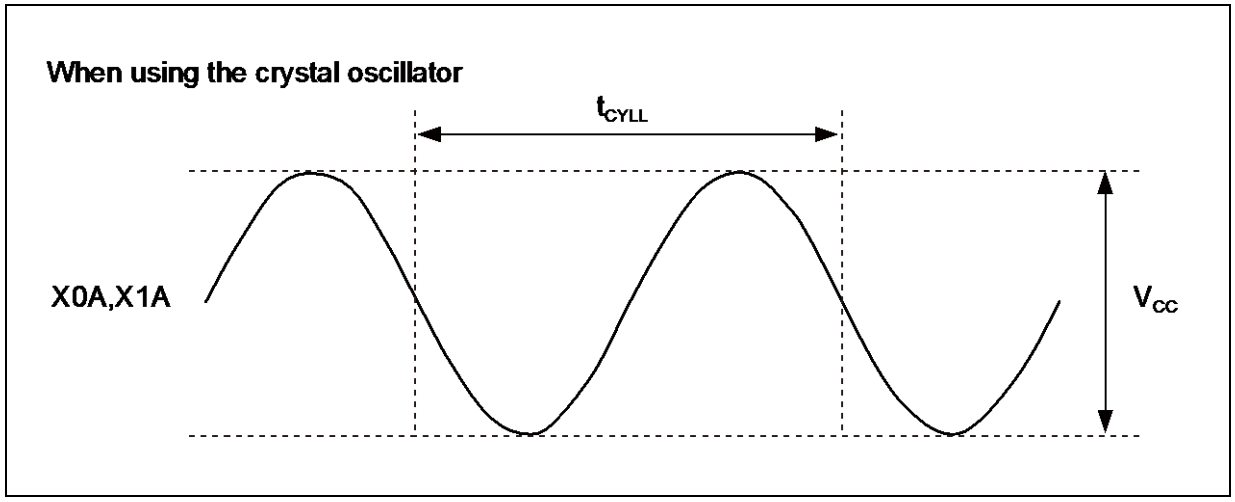
Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

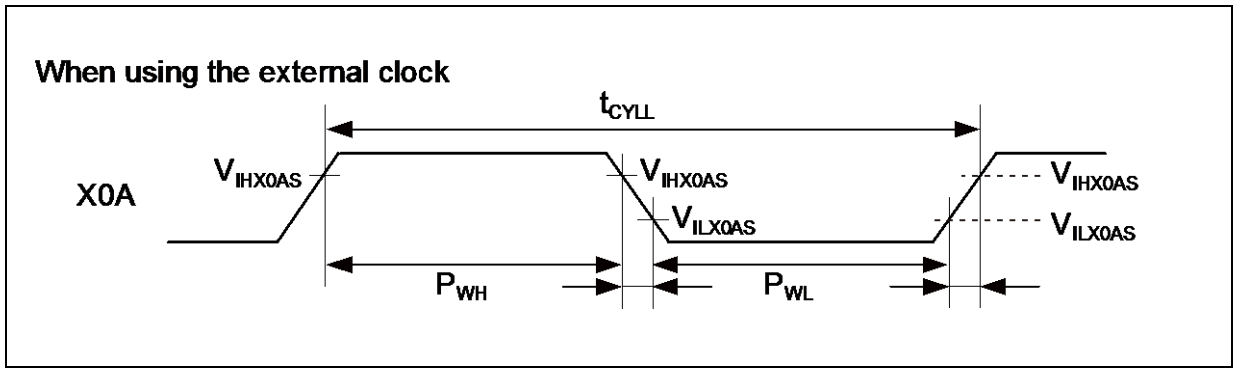
Parameter	Symbol	Pin Name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
"H" level output voltage	V_{OH4}	4mA type	$4.5V \le (D)V_{CC} \le 5.5V$ I_{OH} = -4mA	$(D)V_{CC}$ - 0.5	-	$(D)V_{CC}$	V	
			$2.7V \le (D)V_{CC} < 4.5V$ I_{OH} = -1.5mA					
	V_{OH30}	High Drive type*	$4.5V \le DV_{CC} \le 5.5V$ I_{OH} = -52mA	DV_{CC} - 0.5	-	DV_{CC}	V	T_A = -40°C
			$2.7V \le DV_{CC} < 4.5V$ I_{OH} = -18mA					
			$4.5V \le DV_{CC} \le 5.5V$ I_{OH} = -39mA					T_A = +25°C
			$2.7V \le DV_{CC} < 4.5V$ I_{OH} = -16mA					
			$4.5V \le DV_{CC} \le 5.5V$ I_{OH} = -32mA					T_A = +85°C
			$2.7V \le DV_{CC} < 4.5V$ I_{OH} = -14.5mA					
			$4.5V \le DV_{CC} \le 5.5V$ I_{OH} = -30mA					T_A = +105°C
			$2.7V \le DV_{CC} < 4.5V$ I_{OH} = -14mA					
	V_{OH3}	3mA type	$4.5V \le V_{CC} \le 5.5V$ I_{OH} = -3mA	V_{CC} - 0.5	-	V_{CC}	V	
			$2.7V \le V_{CC} < 4.5V$ I_{OH} = -1.5mA					
"L" level output voltage	V_{OL4}	4mA type	$4.5V \le (D)V_{CC} \le 5.5V$ I_{OL} = +4mA	-	-	0.4	V	
			$2.7V \le (D)V_{CC} < 4.5V$ I_{OL} = +1.7mA					
	V_{OL30}	High Drive type*	$4.5V \le DV_{CC} \le 5.5V$ I_{OL} = +52mA	-	-	0.5	V	T_A = -40°C
			$2.7V \le DV_{CC} < 4.5V$ I_{OL} = +22mA					
			$4.5V \le DV_{CC} \le 5.5V$ I_{OL} = +39mA					T_A = +25°C
			$2.7V \le DV_{CC} < 4.5V$ I_{OL} = +18mA					
			$4.5V \le DV_{CC} \le 5.5V$ I_{OL} = +32mA					T_A = +85°C
			$2.7V \le DV_{CC} < 4.5V$ I_{OL} = +14mA					
			$4.5V \le DV_{CC} \le 5.5V$ I_{OL} = +30mA					T_A = +105°C
			$2.7V \le DV_{CC} < 4.5V$ I_{OL} = +13.5mA					
	V_{OL3}	3mA type	$2.7V \le V_{CC} < 5.5V$ I_{OL} = +3mA	-	-	0.4	V	
	V_{OLD}	DEBUG I/F	V_{CC} = 2.7V I_{OL} = +25mA	0	-	0.25	V	

14.4.2 Sub Clock Input Characteristics

(V_{CC} = AV_{CC} = DV_{CC} = 2.7V to 5.5V, V_{SS} = AV_{SS} = DV_{SS} = 0V, T_A = - 40°C to + 105°C)

Parameter	Symbol	Pin Name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Input frequency	f_{CL}	X0A, X1A	-	-	32.768	-	kHz	When using an oscillation circuit
			-	-	-	100	kHz	When using an opposite phase external clock
		X0A	-	-	-	50	kHz	When using a single phase external clock
Input clock cycle	t_{CYLL}	-	-	10	-	-	µs	
Input clock pulse width	-	-	P_{WH}/t_{CYLL}, P_{WL}/t_{CYLL}	30	-	70	%	

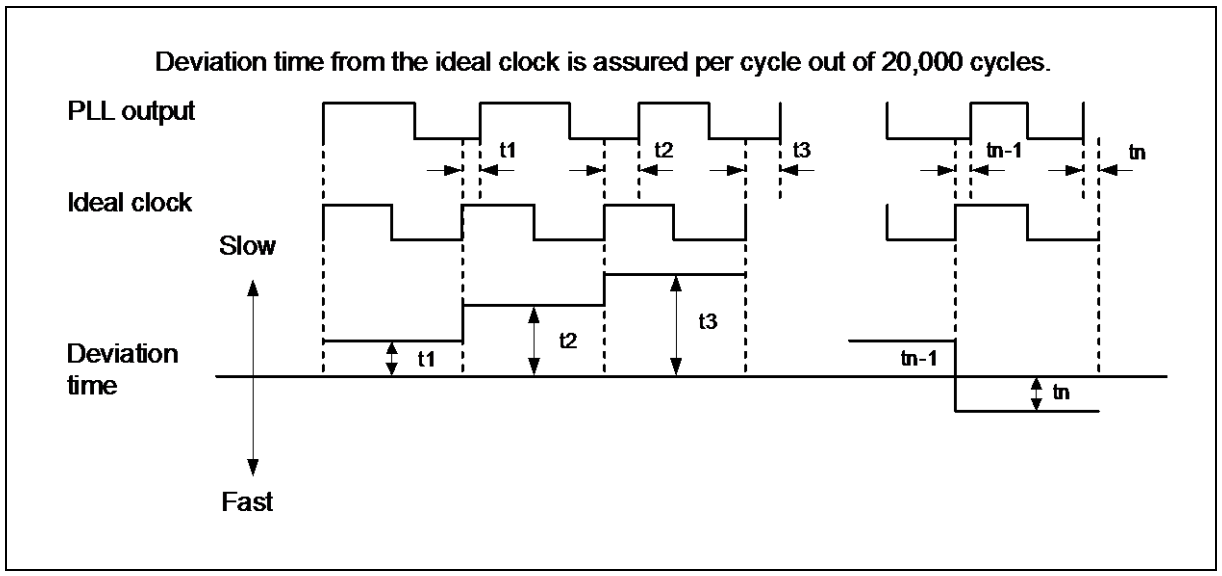




14.4.5 Operating Conditions of PLL

(V_{CC} = AV_{CC} = DV_{CC} = 2.7V to 5.5V, V_{SS} = AV_{SS} = DV_{SS} = 0V, T_A = - 40°C to + 105°C)

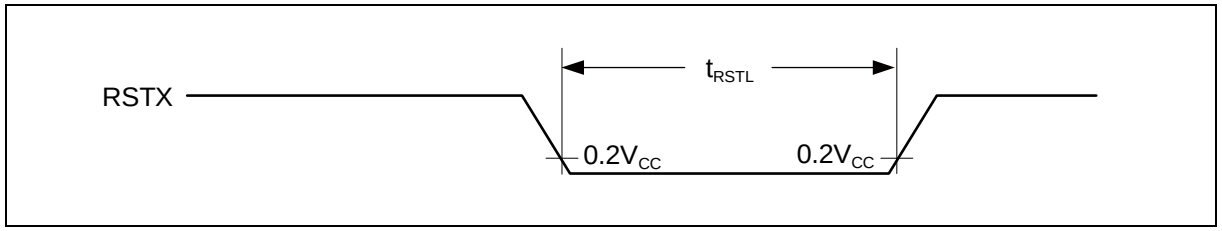
Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
PLL oscillation stabilization wait time	t_{LOCK}	1	-	4	ms	For CLKMC = 4MHz
PLL input clock frequency	f_{PLLI}	4	-	8	MHz	
PLL oscillation clock frequency	f_{CLKVCO}	56	-	108	MHz	Permitted VCO output frequency of PLL (CLKVCO)
PLL phase jitter	t_{PSKEW}	-5	-	+5	ns	For CLKMC (PLL input clock) ≥ 4MHz

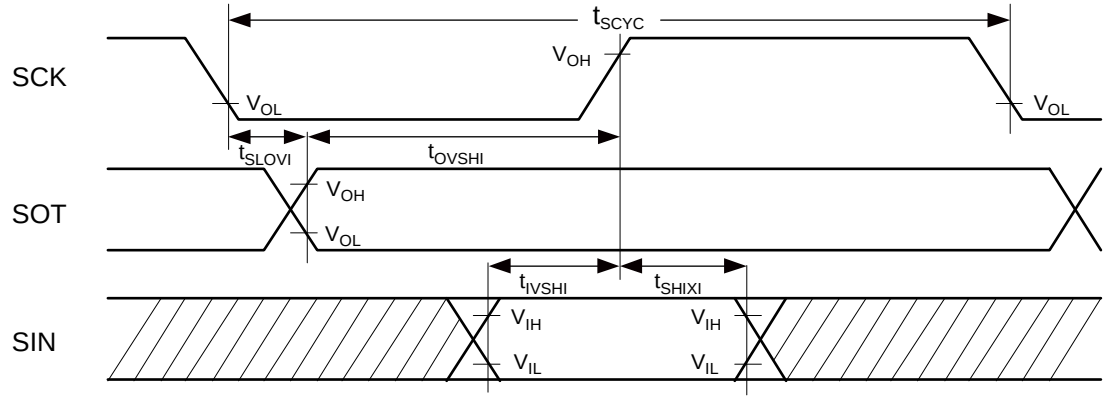


14.4.6 Reset Input

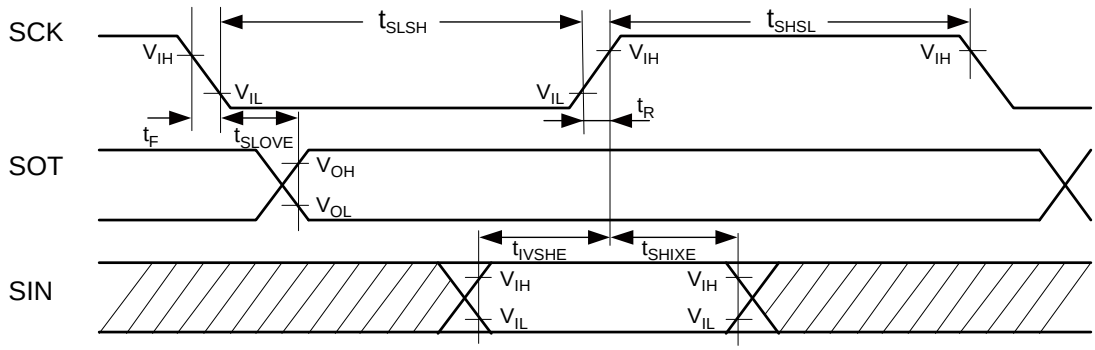
(V_{CC} = AV_{CC} = DV_{CC} = 2.7V to 5.5V, V_{SS} = AV_{SS} = DV_{SS} = 0V, T_A = - 40°C to + 105°C)

Parameter	Symbol	Pin Name	Value		Unit
			Min	Max	
Reset input time	t_{RSTL}	RSTX	10	-	µs
Rejection of reset input time			1	-	µs





Internal shift clock mode



External shift clock mode

14.5 A/D Converter

14.5.1 Electrical Characteristics for the A/D Converter

(V_{CC} = AV_{CC} = DV_{CC} = 2.7V to 5.5V, V_{SS} = AV_{SS} = DV_{SS} = 0V, T_A = - 40°C to + 105°C)

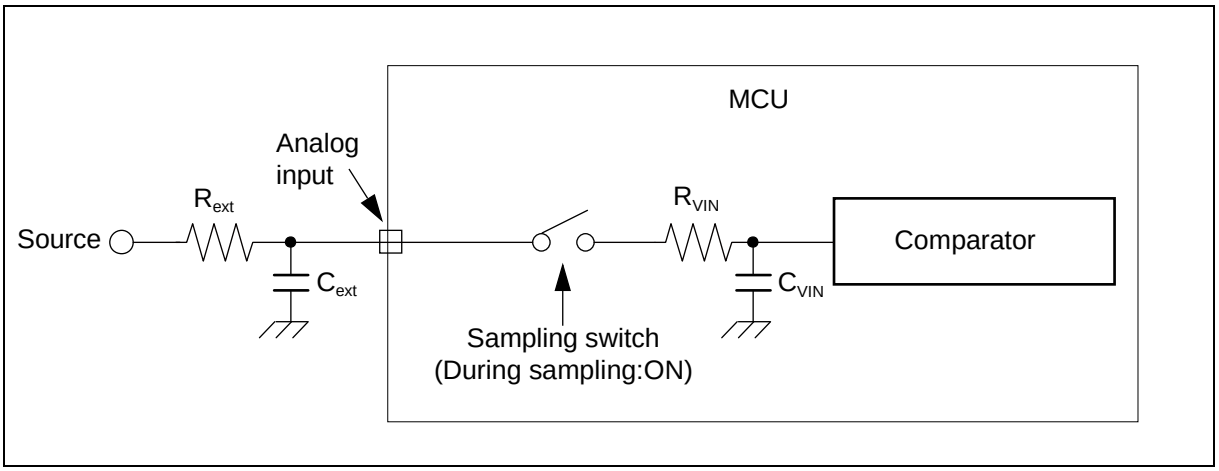
Parameter	Symbol	Pin Name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	-	-	-	-	10	bit	
Total error	-	-	- 3.0	-	+ 3.0	LSB	
Nonlinearity error	-	-	- 2.5	-	+ 2.5	LSB	
Differential Nonlinearity error	-	-	- 1.9	-	+ 1.9	LSB	
Zero transition voltage	V_{OT}	ANn	Typ - 20	AVRL + 0.5LSB	Typ + 20	mV	
Full scale transition voltage	V_{FST}	ANn	Typ - 20	AVRH - 1.5LSB	Typ + 20	mV	
Compare time*	-	-	1.0	-	5.0	µs	4.5V ≤ AV_{CC} ≤ 5.5V
			2.2	-	8.0	µs	2.7V ≤ AV_{CC} < 4.5V
Sampling time*	-	-	0.5	-	-	µs	4.5V ≤ AV_{CC} ≤ 5.5V
			1.2	-	-	µs	2.7V ≤ AV_{CC} < 4.5V
Power supply current	I_A	AV_{CC}	-	2.0	3.1	mA	A/D Converter active
	I_{AH}		-	-	3.3	µA	A/D Converter not operated
Reference power supply current (between AVRH and AVRL)	I_R	AVRH	-	520	810	µA	A/D Converter active
	I_{RH}		-	-	1.0	µA	A/D Converter not operated
Analog input capacity	C_{VIN}	AN0 to 15	-	-	16.0	pF	Normal outputs
		AN16 to 31	-	-	17.8	pF	High current outputs
Analog impedance	R_{VIN}	ANn	-	-	2050	Ω	4.5V ≤ AV_{CC} ≤ 5.5V
			-	-	3600	Ω	2.7V ≤ AV_{CC} < 4.5V
Analog port input current (during conversion)	I_{AIN}	AN0 to 15	- 0.3	-	+ 0.3	µA	AV_{SS} , AVRL < V_{AIN} < AV_{CC}, AVRH
		AN16 to 31	- 3.0	-	+ 3.0	µA	
Analog input voltage	V_{AIN}	ANn	AVRL	-	AVRH	V	
Reference voltage range	-	AVRH	AV_{CC} - 0.1	-	AV_{CC}	V	
	-	AVRL	AV_{SS}	-	AV_{SS} + 0.1	V	
Variation between channels	-	ANn	-	-	4.0	LSB	

*: Time for each channel.

14.5.2 Accuracy and Setting of the A/D Converter Sampling Time

If the external impedance is too high or the sampling time too short, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting the A/D conversion precision.

To satisfy the A/D conversion precision, a sufficient sampling time must be selected. The required sampling time (Tsamp) depends on the external driving impedance R_{ext}, the board capacitance of the A/D converter input pin C_{ext} and the AV_{CC} voltage level. The following replacement model can be used for the calculation:



R_{ext}: External driving impedance

C_{ext}: Capacitance of PCB at A/D converter input

C_{VIN}: Analog input capacity (I/O, analog switch and ADC are contained)

R_{VIN}: Analog input impedance (I/O, analog switch and ADC are contained)

The following approximation formula for the replacement model above can be used:

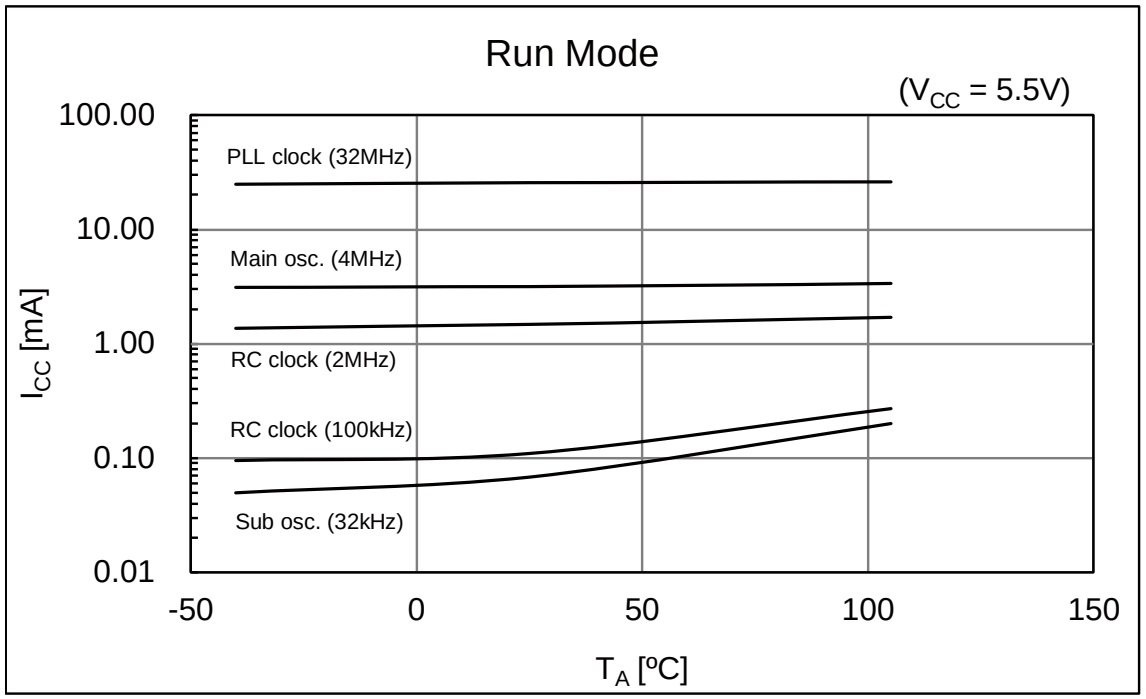
$$Tsamp = 7.62 \times (Rext \times Cext + (Rext + R_{VIN}) \times C_{VIN})$$

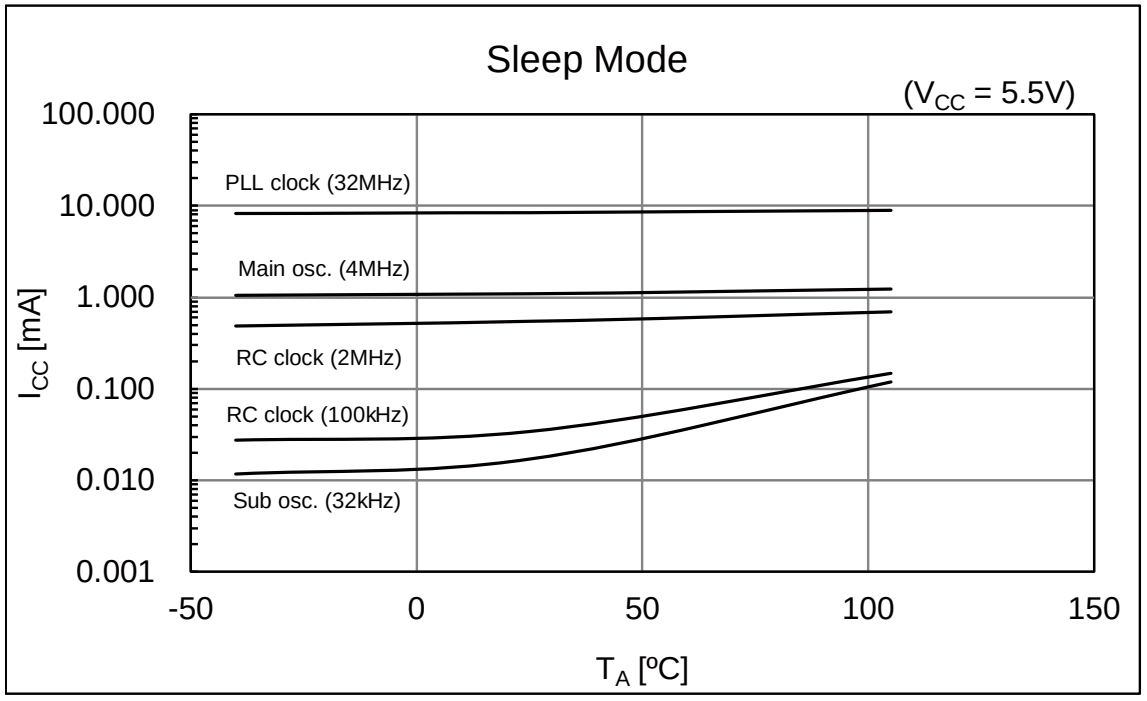
- Do not select a sampling time below the absolute minimum permitted value. (0.5µs for 4.5V ≤ AV_{CC} ≤ 5.5V, 1.2µs for 2.7V ≤ AV_{CC} < 4.5V)
- If the sampling time cannot be sufficient, connect a capacitor of about 0.1µF to the analog input pin.
- A big external driving impedance also adversely affects the A/D conversion precision due to the pin input leakage current IIL (static current before the sampling switch) or the analog input leakage current IAIN (total leakage current of pin input and comparator during sampling). The effect of the pin input leakage current IIL cannot be compensated by an external capacitor.
- The accuracy gets worse as |AVRH - AVRL| becomes smaller.

15. Example Characteristics

This characteristic is an actual value of the arbitrary sample. It is not the guaranteed value.

■CY96F6A6





Page	Section	Change Results
		Added part number MCU with CAN controller MB96F6A5RBPMC-GSE1 MB96F6A5RBPMC-GSE2 MCU without CAN controller MB96F6A5ABPMC-GSE1 MB96F6A5ABPMC-GSE2
Revision 1.1		
-	-	Company name and layout design change
Rev.*B		
-	Marketing Part Numbers changed from an MB prefix to a CY prefix.	
5, 7, 66, 67	1. Product Lineup 3. Pin Assignment 16. Ordering Information 17. Package Dimension	Package description modified to JEDEC description. FPT-120P-M21 → LQM120
66	16. Ordering Information	Revised Marketing Part Numbers as follows: Before) **MCU with CAN controller** MB96F6A5RBPMC-GSE1 MB96F6A5RBPMC-GSE2 MB96F6A6RBPMC-GSE1 MB96F6A6RBPMC-GSE2 **MCU without CAN controller** MB96F6A5ABPMC-GSE1 MB96F6A5ABPMC-GSE2 After) **MCU with CAN controller** CY96F6A6RBPMC-GS-UJE1 CY96F6A6RBPMC-GS-UJE2 CY96F6A6RBPMC-GS-UJERE2

NOTE: Please see “Document History” about later revised information.